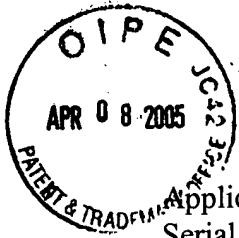


Hw



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Gerd Frankowsky et al.      Art Unit : 2811  
Serial No. : 10/630,632      Examiner : Joseph H Nguyen  
Filed : July 29, 2003  
Title : SEMICONDUCTOR CIRCUIT MODULE AND METHOD FOR FABRICATING  
SEMICONDUCTOR CIRCUIT MODULES

**Mail Stop Amendment**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT IN REPLY TO ACTION OF FEBRUARY 23, 2005

Please amend the above-identified application as follows:

CERTIFICATE OF MAILING BY FIRST CLASS MAIL

I hereby certify under 37 CFR §1.8(a) that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

4/6/05  
Date of Deposit

Signature

Leja Zaremboch  
Typed or Printed Name of Person Signing Certificate